## What is claimed is:

- 1. A needle fixture of a probe card in semiconductor inspection equipment comprising:
  - a printed circuit board;
  - a needle fixture installed in the printed circuit board;
- a resin unit affixing a probe needle to the needle fixture using an adhesive; and

a separation preventer for preventing separation of the resin unit from the needle fixture, wherein the separation preventer includes:

a plurality of notches formed along a bottom surface of the needle fixture; and

the adhesive filling the plurality of notches.

- 2. The needle fixture of the probe card according to claim 1, wherein the adhesive is an epoxy resin.
- 3. The needle fixture of the probe card according to claim 1, wherein the plurality of notches are formed along the entire bottom surface of the needle fixture.
- 4. The needle fixture of the probe card according to claim 1, wherein a side sectional shape of the plurality of notches is a polygon.

- 5. The needle fixture of the probe card according to claim 4, wherein the polygon is a trapezoid.
- 6. The needle fixture of the probe card according to claim 1, wherein a side sectional shape of the plurality of notches is a curve.
- 7. The needle fixture of the probe card according to claim 6, wherein the curve has the shape of the Greek letter " $\Omega$ ".
- 8. A needle fixing method in a probe card of semiconductor inspection equipment fixing a probe needle to a needle fixture using an adhesive, comprising:

forming a plurality of notches along a bottom surface of the needle fixture;

depositing a first resin layer on the bottom surface of the needle fixture to cover and fill the plurality of notches;

depositing a second resin layer on a predetermined position of the probe needle;

contacting an exposed bottom surface of the first resin layer with an exposed upper surface of the second resin layer; and

heating the first and the second resin layers to melt and fuse the first and second resin layers.

- 9. The needle fixing method in the probe card according to claim 8, wherein the adhesive is an epoxy resin.
- 10. The needle fixing method in the probe card according to claim 8, wherein depositing the first resin layer comprises:

depositing the first resin layer to a uniform predetermined thickness over and in the plurality of notches on the bottom surface of the needle fixture.

- 11. The needle fixing method in the probe card according to claim 8, wherein the plurality of notches are formed along the entire bottom surface of the needle fixture.
- 12. The needle fixing method in the probe card according to claim 8, wherein a side sectional shape of the plurality of notches is a polygon.
- 13. The needle fixing method in the probe card according to claim 12, wherein the polygon is a trapezoid.
- 14. The needle fixing method in the probe card according to claim 8, wherein a side sectional shape of the plurality of notches is a curve.

15. The needle fixing method in the probe card according to claim 14, wherein the curve has the shape of the Greek letter " $\Omega$ ".